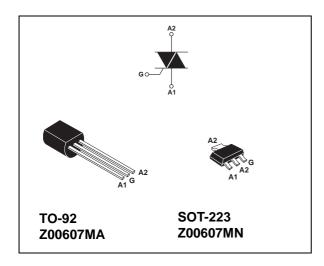


Standard 0.8 A Triacs

Datasheet - production data



Description

The Z00607 is suitable for low power AC switching applications. Typical applications include home appliances (electrovalve, pump, door lock, small lamp control), fan speed controllers,...

Thanks to the low gate triggering current these triacs can be driven directly by microcontrollers.

Features

- On-state rms current = 0.8 A
- Repetitive peak off-state voltage = 600 V
- Gate triggering current = 5 mA

Characteristics Z00607

1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Parameter			Value	Unit
	On-state rms current	SOT-223	T _{tab} = 85 °C	0.8	А
IT(RMS)	I _{T(RMS)} (full sine wave)	TO-92	T _L = 50 °C	0.0	
1	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	9	Α
ITSM	current (full cycle, T _j initial = 25 °C)	F = 60 Hz	t = 16.7 ms	9.5	A
l ² t	I^2t Value for fusing $t_p = 10 \text{ ms}$		0.45	A ² s	
dI/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , $t_r \le 100$ ns		T _j = 110 °C	20	A/µs
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 110 °C	1	Α
P _{G(AV)}	Average gate power dissipation $T_j = 110 ^{\circ}\text{C}$			0.1	W
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 110	°C

Table 2. Electrical characteristics ($T_j = 25$ °C, unless otherwise specified)

Symbol	Test Conditions	Quadrant		Value	Unit	
I _{GT} ⁽¹⁾		I - II - III	MAX	5	mA	
'GT`	$V_D = 12 \text{ V}, R_L = 30 \Omega$	IV	IVIAA	7		
V _{GT}		ALL	MAX	1.3	V	
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$, $T_j = 110 \text{ °X}$		MIN	0.2	V	
I _H ⁽²⁾	I _T = 200 mA		MX.	5	mA	
1	I _G = 1.2 I _{GT}	I - III - IV	MAX	10	mA	
IL	I'G = 1.2 IGT	II	IVIAA	20	IIIA	
dV/dt (2)	V_D = 67% V_{DRM} , gate open T_j = 110 $^{\circ}X$		MIN	10	V/µs	
(dV/dt)c (2)	$(\delta\varsigma/\delta\tau)\chi = 0.35 \text{ A/ms}, T_j = 110 \text{ °X}$			1.5	V/µs	

^{1.} minimum I_{GT} is guaranteed at 5% of I_{GT} max.

Table 3. Static characteristics

Symbol	Test Conditions			Value	Unit
V _{TM} ⁽¹⁾	$I_{TM} = 1.1 \text{ A}$ $t_p = 380 \mu\text{s}$	T _j = 25 °C	MAX.	1.5	V
V _{to} (1)	Threshold voltage	T _j = 110 °C	MAX.	0.95	V
R _d ⁽¹⁾	Dynamic resistance	T _j = 110 °C	MAX.	420	mΩ
I _{DRM}	V - V - 600 V	T _j = 25 °C	MAX.	5	μA
I _{RRM}	$V_{DRM} = V_{RRM} = 600 \text{ V}$	T _j = 110 °C	IVIAA.	0.1	mA

^{1.} for both polarities of A2 referenced to A1.

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^{2.} for both polarities of A2 referenced to A1.

Z00607 Characteristics

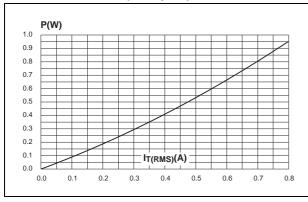
Table 4. Thermal resistances

Symbol	Parameter			Value	Unit
R _{th(j-t)}	Junction to tab (AC)		SOT-223	25	°C/W
R _{th(j-l)}	Junction to lead (AC)		TO-92	60	C/VV
D. Lungtion to problem		$S^{(1)} = 5 \text{ cm}^2$	SOT-223	60	°C/W
$R_{th(j-a)}$	Junction to ambient		TO-92	150	C/VV

^{1.} S = Copper surface under tab.

Figure 1. Maximum power dissipation versus RMS on-state current (full cycle)

Figure 2. Relative variation of gate trigger, holding and latching current versus junction temperature



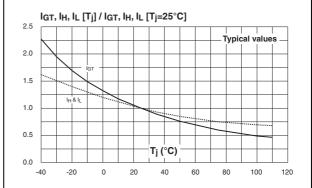
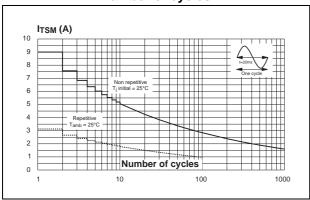
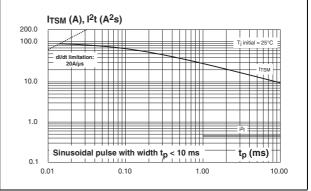


Figure 3. Surge peak on-state current versus number of cycles

Figure 4. Non-repetitive surge peak on-state current and corresponding value of I²t

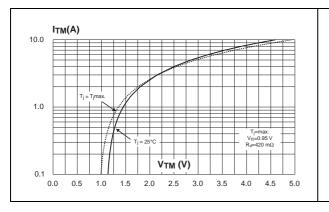




Characteristics Z00607

Figure 5. On-state characteristics (maximum values)

Figure 6. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)



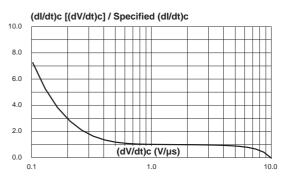
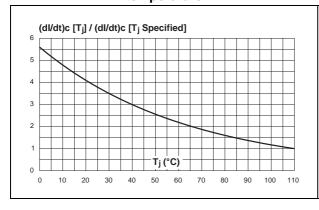
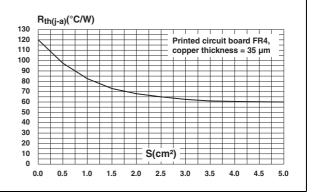


Figure 7. Relative variation of critical rate of decrease of main current versus junction temperature

Figure 8. SOT-223 Thermal resistance junction to ambient versus copper surface under tab



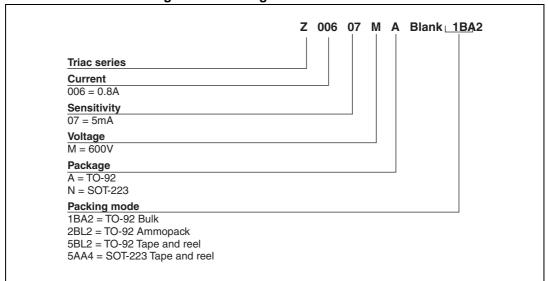


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2 Ordering information scheme

Figure 9. Ordering information scheme





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3 Packaging information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Dimensions Ref. **Millimeters** Inches Min. Тур. Max. Min. Тур. Max. Α 1.80 0.071 Α1 0.10 0.001 0.004 0.02 В 0.60 0.70 0.85 0.024 0.027 0.033 0.114 0.124 В1 2.90 3.00 3.15 0.118 0.24 0.26 0.35 0.009 0.010 0.014 $D^{\overline{(1)}}$ 0.248 0.256 0.264 6.30 6.50 6.70 2.3 0.090 е 0.181 e1 4.6 $E^{\overline{(1)}}$ 3.30 0.138 0.146 3.50 3.70 0.130 Н 7.00 7.30 0.264 0.276 0.287 6.70 ٧ 10° max

Table 5. SOT-223 dimensions

1. Do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm (0.006inches)

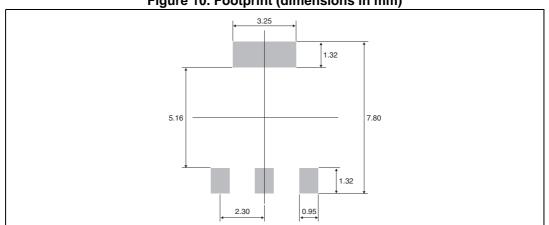


Figure 10. Footprint (dimensions in mm)

Z00607 Ordering information

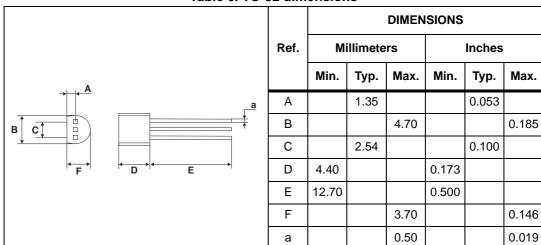


Table 6. TO-92 dimensions

4 Ordering information

Table 7. Ordering information

Ordering type	Marking	Package	Weight	Base quantity	Delivery mode
Z00607MA 1BA2	Z0607MA			2500	Bulk
Z00607MA 2BL2	Z0607MA	TO-92	0.2 g	2000	Ammopack
Z00607MA 5BL2	Z0607MA			2000	Tape and reel
Z00607MN 5AA4	Z06M	SOT-223	0.12 g	1000	Tape and reel

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
Oct-2001	4	Last update.
25-Mar-2005	5	Package: TO-92 tape and reel delivery mode 5BL2 added.
21-Jun-2005	6	Markings updated from Z006xxxx to Z06xxxx
13-Sep-2005	7	Z00607MA 2BL2: marking corrected from 00607mA to Z0607MA
12-Apr-2007	8	Reformatted to current standard. Added SOT-223 package. Changed Tj from +125 to +110 in <i>Table 1</i>
19-Jun-2014	9	Updated marking for Z00607MN 5AA4 in <i>Table 7</i> .



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